

DATA SHEET



N-Channel Silicon MOSFET 2SK3977 — General-Purpose Switching Device **Applications**

Features

- · Low ON-resistance.
- Ultrahigh-speed switching.
- 4.5V drive

Specifications

Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Conditions	Ratings	Unit
Drain-to-Source Voltage	VDSS		100	V
Gate-to-Source Voltage	VGSS		±20	V
Drain Current (DC)	۱ _D		10	А
Drain Current (Pulse)	IDP	PW≤10µs, duty cycle≤1%	40	А
Allowable Power Dissipation	D-		1	W
	PD	Tc=25°C	20	W
Channel Temperature	Tch		150	°C
Storage Temperature	Tstg		-55 to +150	°C

Electrical Characteristics at Ta=25°C

Parameter	Symbol	Conditions	Ratings			Linit
			min	typ	max	Unit
Drain-to-Source Breakdown Voltage	V(BR)DSS	ID=1mA, VGS=0V	100			V
Zero-Gate Voltage Drain Current	IDSS	VDS=100V, VGS=0V			1	μΑ
Gate-to-Source Leakage Current	IGSS	V _{GS} =±16V, V _{DS} =0V			±10	μΑ
Cutoff Voltage	VGS(off)	V _{DS} =10V, I _D =1mA	1.2		2.6	V
Forward Transfer Admittance	yfs	VDS=10V, ID=6A	6	10		S
Static Drain-to-Source On-State Resistance	R _{DS} (on)1	ID=6A, VGS=10V		70	92	mΩ
	RDS(on)2	ID=6A, VGS=4.5V		85	120	mΩ
Input Capacitance	Ciss	VDS=20V, f=1MHz		1560		pF
Output Capacitance	Coss	V _{DS} =20V, f=1MHz		130		pF
Reverse Transfer Capacitance	Crss	VDS=20V, f=1MHz		83		pF
Turn-ON Delay Time	td(on)	See specified Test Circuit.		16		ns
Rise Time	tr	See specified Test Circuit.		55		ns
Turn-OFF Delay Time	td(off)	See specified Test Circuit.		120		ns
Fall Time	tf	See specified Test Circuit.		80		ns

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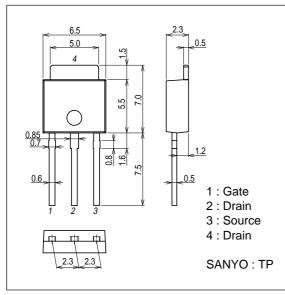
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Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	Unit
Total Gate Charge	Qg	VDS=50V, VGS=10V, ID=10A		34		nC
Gate-to-Source Charge	Qgs	V _{DS} =50V, V _{GS} =10V, I _D =10A		5.5		nC
Gate-to-Drain "Miller" Charge	Qgd	VDS=50V, VGS=10V, ID=10A		6		nC
Diode Forward Voltage	VSD	IS=10A, VGS=0V		0.95	1.2	V

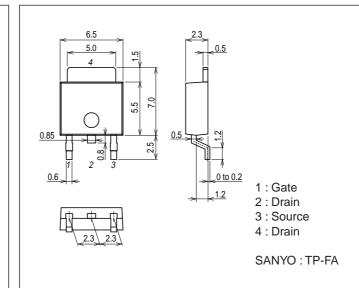
Package Dimensions

unit : mm (typ) 7518-004

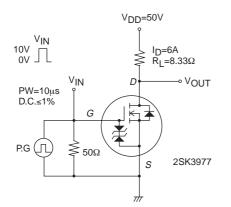


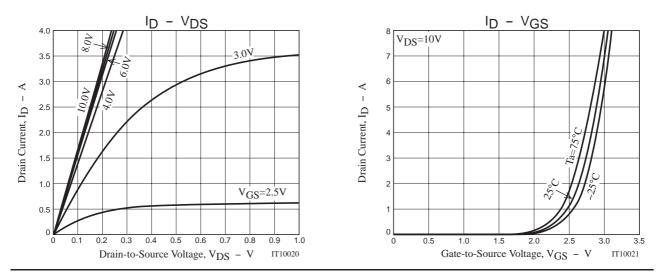
Package Dimensions

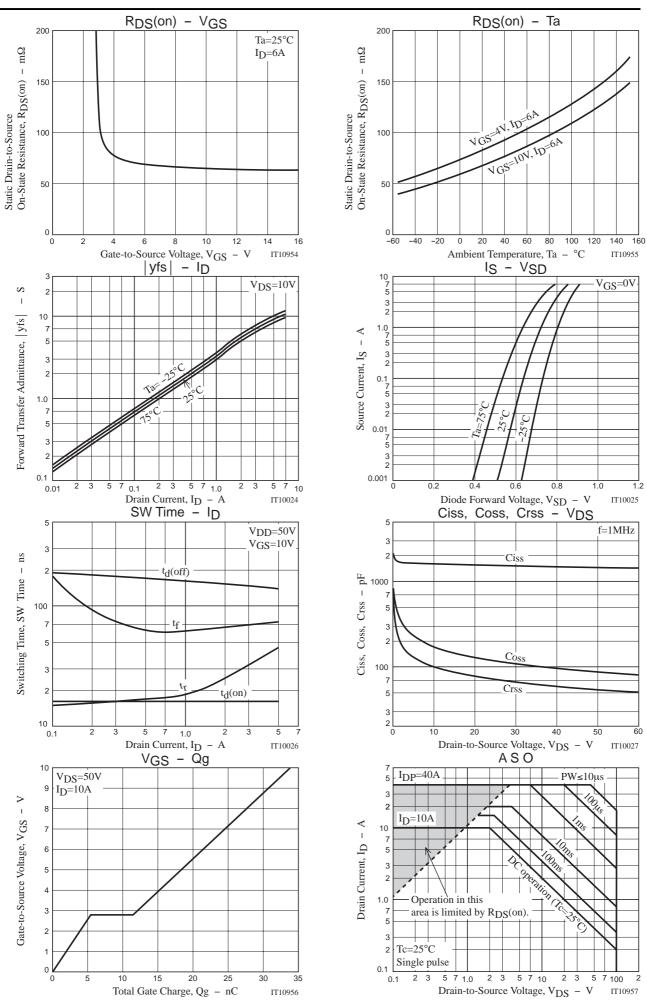
unit : mm (typ) 7003-004



Switching Time Test Circuit







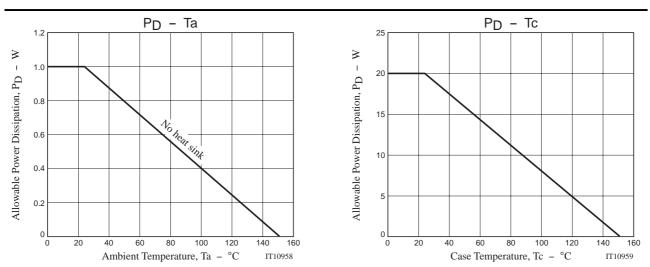
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Note on usage : Since the 2SK3977 is a MOSFET product, please avoid using this device in the vicinity of highly charged objects.

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